



<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>				APPLICATION NO.: 10/021,740	ATTY. DOCKET NO.: M0925.70108US00
				FILING DATE: October 22, 2001	CONFIRMATION NO.: 1110
				APPLICANT: Yet-Ming Chiang et al.	
				GROUP ART UNIT: 1745	EXAMINER: J.S. Maples
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**OTHER ART — NON PATENT LITERATURE DOCUMENTS**

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EXAMINER:	DATE CONSIDERED:
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# EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

\*a copy of this reference is not provided as it was previously cited by or submitted to the office in a prior application, Serial No. \_\_, filed \_\_, and relied upon for an earlier filing date under 35 U.S.C. 120 (continuation, continuation-in-part, and divisional applications).

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